RENESAS

RC21012A/RC31012A

This document describes the following topics about the RC21012A/RC31012A programmer board:

- Basic hardware and GUI setup
- Instructions to burn OTP memory of a device from the GUI

Computer Requirements

- USB 2.0 or USB 3.0 Interface
- Processor: Minimum 1GHz
- Memory:
 - Minimum: 512MB
 - Recommended: 1GB
- Available disk space:
 - Minimum: 600MB (1.5GB 64-bit)
 - Recommended: 1GB (2GB 64-bit)

Board Contents

- RC21012A/RC31012A programmer board
- Programmer board manual
- Configuration software (Renesas IC Toolbox)
- Board schematic and BOM

Features

- USB power supply
- Specialized device socket
- Access to two differential input clocks
- Test points for eight differential output clocks
- XIN terminal can use laboratory signal generator or OCXO/TCXO/XO components and board
- Serial port for configuration and register read out



Figure 1. RC21012A/RC31012A Programmer Board



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1. Functional Description

This programmer board is used to program blank RC21012A/RC31012A devices with on-board USB interface and the RICBox GUI (for more information about RICBox, see the RICBox product page). The kit can also be used to test general device configuration output frequency and GPI/GPIO settings.

Note: The RC21012A/RC31012A programmer board is not intended to evaluate device performance. For information about the device evaluation kit, visit the RC21012A/RC31012A EVK product page.

1.1 **Operational Characteristics**

The RC21012A/RC31012A programmer board is equipped with a single on-board LDO that takes voltage in from USB and supplies 3.3V to all device domains. The board is designed to plug directly into any PC and be ready for use with the RICBox GUI and blank part.

A 25MHz crystal is mounted onto the board for testing without external clock input. Up to two input clocks can be configured for use through selection jumpers (J4). A 48-pin socket is mounted to the top of the board for easy replacement of blank devices.

The RC21012A/RC31012A programmer board is compatible with most 48-pin variants of the RC21012A/RC31012A.

Note: It is recommended to use a high-speed USB interface to allow for higher current draw.

Note: Use proper grounding to avoid ESD damage to the devices and the programmer board.



1.2 Hardware Setup and Configuration

Figure 2. Programmer Board with Labels

1.2.1. Part Placement

Part placement should follow the first pin marked on both the programmer board socket and blank part. Ensure both markings match before placing the part into the socket.



Figure 3. Pin 1 Location

Note: It is *critical* to ensure that pin 1 markings match between the board and device; otherwise, this may cause electrical shorting and possible damager/harm!

The socket opens by gently pushing in the small tab on the front side of the socket to release lid.



Figure 4. Socket Open Tab

To close, align the top of the socket with the bottom and press down until the socket clicks in place.



Figure 5. Closing Socket

Note: Do not force the socket lid down onto a part. This may damage the part or the socket itself.

1.2.2. Jumper Selection

The RC21012A/RC31012A programmer board is equipped with five GPIO selection jumpers (J5-J9), four GPI selection jumpers (J10-J13), and a jumper strip for XIN/CLKIN trace paths (J4).

The GPIO and GPI jumpers can be pulled high or low by placing a jumper shunt between the center pin and VDD, or GND accordingly.



Figure 6. GPIO Jumper Settings

Jumper pins at J4 can configure CLKIN and XIN traces to the socket pins. Table 1 shows the different orientations for J4. CLKIN traces can be directed to GPIO.

Pins	Description
1/2	Connect the onboard crystal to pin 2 (XIN_REFIN)
3/4	Connect J2 (SMA_1_IN) to pin 2 (XIN_REFIN)
5/6	Connect J2 (SMA_1_IN) to pin 5 (CLKIN0_GPI0)
7/8	Connect J2 (SMA_1_IN) to pin 8 (CLKIN1_GPI2)
9/10	Connect J3 (SMA_2_IN) to pin 6 (CLKIN0B_GPI1)
11/12	Connect J3 (SMA_2_IN) to pin 9 (CLKIN1B_GPI3)

Table 1. J4 Jumper Selection





Figure 7. J4 Side-by-Side View

1.3 Software Setup and Configuration

1.3.1. Software Installation

The RC21012A/RC31012A programmer board is compatible with the RICBox VersaClock 7 plugin. The plugin can be used to interface with the device via register read/writes. For instructions regarding installation of RICBox or any of the device plug-ins, see the RICBox product page.

Note: Be sure to update to the latest version of the RICBox GUI and VersaClock 7 plug-in before interfacing with the RC21012A/RC31012A programmer board.

1.3.2. Programming OTP Memory

Programming OTP memory can be done easily inside the RICBox GUI. The RC21012A/RC31012A can program up to 27 configurations into OTP memory. To ensure that OTP memory is programmed correctly, complete the following procedure:

- 1. Place a device in the socket and connect the programmer board to a PC, with RICBox and the VersaClock 7 plug-in installed, via the USB connector.
- 2. Open RICBox and navigate to an existing RC21008A or RC31008A settings file, or create a new configuration.

Ensure that the correct XIN and CLKIN settings are set based on J4, and the signals are driven in the programmer board depending on the configuration loaded.

- 3. Once a configuration is open, go to the block diagram view.
- 4. Click on the OTP/EEPROM button in the lower left corner to view the OTP/EEPROM pop-up.



Figure 8. OTP Pop-up Page

- 5. Use the Configuration Type drop-down menu to select between the following:
 - NoConfig Nothing will be programmed to OTP memory.
 - SingleConfig Program a single configuration into the OTP common configuration.
 - StaticMultiConfig Program multiple configurations into a device that can be selectable at device start-up.
 - DynamicMultiConfig Program multiple configurations into a device that can be selectable at start-up and runtime.

Configuration Type	
NoConfig ~	
NoConfig	
SingleConfig	
StaticMultiConfig	
DynamicMultiConfig	

Figure 9. Configuration Type Menu

6. If *StaticMultiConfig* is selected in the configuration type menu, the Startup User Config Selection section can now be used to set configuration selection bits. Bits can either be hard coded to a low, middle, or high values, or bits can be selected through GPIO at start-up.

Select the setting that best matches how the configuration selection bits should be arranged for this application.

Configuration Type	Startup User Co	nfig Selection
	Config Select Input 0	StaticCSEL.Gpio 🗸
StaticMultiConfig ~ 🔒	Config Select Input 1	StaticCSEL.Low StaticCSEL.Mid
	Config Select Input 2	StaticCSEL.Gpio
		StaticCSEL.High
	These values for DEVICE_ set the configuration s	CNFG.static_csel[x] election inputs.

Figure 10. StaticMultiConfig Menu

7. If *DynamicMultiConfig* is selected in the configuration type menu, the Dynamic User Config Selection section can now be used to set configuration selection bits. These have the same options as in StaticMultiConfig, except there are additional options to allow for differing types of input.

Select the setting that best suits how the configuration selection bits should be arranged for this application.

Configuration Type	Startup User Config Selection	Dynamic User Config Selection
	Config Select Input 0 StaticCSEL.Gpio 🕤 💕	Config Select Input 0 DynamicCSEL v
DynamicMultiConfig ~ 🔒	Config Select Input 1 Static SEL Gold	Config Select Input 1 DynamicCSEL.TriLevel
		DynamicCSEL.BiLevel
	Config Select Input 2 StaticCSEL.Gpio 🕤	Config Select Input 2 DynamicCSEL.NotUsed
		DynamicCSEL.TriLevelPullUpAndPullDr
		DEVICE_CNFG.pwrdn_se DynamicCSEL.TriLevelPullUp
		DynamicCSEL.TriLevelPullDn
		These selec DynamicCSEL.BiLevelPullDn
	These values for DEVICE_CNFG.static_csel[x]	DEVICE_CNFG.static_csel DynamicCSEL.BiLevelPullUp
	set the configuration selection inputs.	When a GPIO is assigned, relay StaticCSEL.Low
		settings file(s) to allow

Figure 11. DynamicMultiConfig Menu

- 8. Select the configs to load into OTP from RICBox.
 - Default setting is for the current working configuration.
 - Ensure all necessary configs are selected and all warnings/errors are cleared.

			Po	opulate all con ultiple config	nfig ura	j slo tion	ts for modes					
	select [2]	select [1]	select [0]			cion	modeo	select [2]	select [1]	select [0]		
Single Config				config_slot_0	~		Config 13	М	М	•	config_slot_14	-
Config 0	L	L	L	default	~	â	Config 14	М	М	•	config_slot_15	-
Config 1	L	L	м	default	~	â	Config 15	М	н	•	config_slot_16	-
Config 2	L	L	н	default	~	â	Config 16	М	н	•	config_slot_17	-
Config 3	L	М	L.	config_slot_4	~	Ð	Config 17	М	н	•	config_slot_18	-
Config 4	L	М	M	config_slot_5	~	đ	Config 18	н	L	•	config_slot_19	-
Config 5	L	М	н	config_slot_6	~	C	Config 19	н	L	•	config_slot_20	-
Config 6	L	н		config_slot_7	~	Ð	Config 20	н	L	•	config_slot_21	-
Config 7	L	н	M	config_slot_8	~	đ	Config 21	н	М	•	config_slot_22	-
Config 8	L	н	HI	config_slot_9	~	6	Config 22	н	М	•	config_slot_23	-
Config 9	М	L	L.	config_slot_10	×	đ	Config 23	н	М	•	config_slot_24	-
Config 10	М	L	M	config_slot_11	~	6	Config 24	н	н	•	config_slot_25	ſ
Config 11	М	L	н	config_slot_12	v	ſ	Config 25	н	н	•	config_slot_26	ſ
Config 12	М	М	۱.	config_slot_13	~		Config 26	н	н	•	config_slot_27	- 6

Figure 12. Config Selection Options

9. Establish a connection to the device in socket.



Figure 13. Device Connection

10. Press the "Program OTP" button on the OTP/EEPROM page.

	OTP
Pressing the "Pro OTP of the conn with the new des device. Please note that while programmir some time for the	gram OTP" button will read the existing ected device, update the OTP contents sired OTP configuration and program the there is currently no progress indicator ng is occuring, and that it can take quite task to complete.
	Program OTP

Figure 14. Program OTP

2. Board Design





Figure 15. RC21012A/RC31012A Evaluation Board (Top)

Figure 16. RC21012A/RC31012A Evaluation Board (Bottom)

2.1 Schematic Diagrams

The RC21012A/RC31012A schematic diagrams are located at the end of this document.

2.2 Bill of Materials

Manufacturer Part Number Qty. **Reference Designator** Description 3 C1 C3 C10 X5R Surface Mount Capacitor **Murata Electronics** ZRB15XR61A475ME01 C2 C4 C5 C6 C7 C8 C11 C15 C18 X7R Surface Mount Capacitor **Murata Electronics** GRM155R71C104KA88D 11 C20 C22 C12 COG Surface Mount Capacitor **Murata Electronics** GRM155R71E103J 1 2 C13 C14 COG Surface Mount Capacitor Murata Electronics GRM1555C1E270J 2 C16 C17 X7T Surface Mount Capacitor **Murata Electronics** GRM188D70J106MA73D 1 C19 X5R Surface Mount Capacitor Murata Electronics GRM188R60J226M C21 GCM188R71E105KA64D 1 X7R Surface Mount Capacitor Murata Electronics C23 C28 C29 C30 C31 C32 C33 C0603X6S1C104K030 12 X6S Surface Mount Capacitor Kemet C34 C35 C36 C37 C38 C25 C26 2 COG Surface Mount Capacitor Murata Electronics GCM1555C1H6R8BA16D 1 C27 Murata Electronics GRM155R71H102KA01D X7R Surface Mount Capacitor **OSRAM: LED Green Diffused** OSRAM D1 LG L29K-G2J1-24-Z 1 0603 Surface Mount Fast Switching 1N4448HLP 1 D2 Diodes Diode: Io=95mA, Vr=80V, trr=4ns Incorporated MURATA: Ferrite Bead 600 Ohm 4 FB1 FB2 FB3 FB4 Murata BLM18AG601SN1D 0603 J1 TE: USB-A (USB TYPE-A) USB **TE Connectivity** 1734028-1 1 2.0 Plug Connector 4 Position Surface Mount, Right Angle; Through Hole Samtec: SMA JACK STR 50 2 J2 J3 Samtec SMA-J-P-H-ST-EM1 OHM EDGE MNT, Fits 0.062" board J4 Molex C-Grid Header Dual, Gold, Molex 10-89-7120 1 Unshrouded, Breakaway, 100mil pitch J5 J6 J7 J8 J9 J10 J11 J12 J13 Molex: Header, Gold, 22-28-4033 q Molex Unshrouded, Breakaway, 100mil pitch, 0.240 inch contact mating length R1 R6 R10 R11 R12 R14 Surface Mount Resistor Yageo RC0402JR-0710KL 6 R2 Surface Mount Resistor DNI 1 R3 Surface Mount Resistor RC0402JR-071KL 1 Yageo

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Qty.	Reference Designator	Description	Manufacturer	Part Number	
4	R4 R5 R7 R8	Surface Mount Resistor	Panasonic	ERJ-2GEJ100X	
1	R9	Surface Mount Resistor	Panasonic	ERJ-2GEJ123X	
1	R13	Surface Mount Resistor	Vishay	CRCW040227K0FK	
2	R15 R40	Surface Mount Resistor	Panasonic	ERJ-2RKF49R9X	
24	R16 R17 R18 R19 R20 R21 R22 R23 R24 R25 R26 R27 R28 R29 R30 R31 R32 R33 R34 R35 R36 R37 R38 R39	Surface Mount Resistor	Panasonic	ERJ-1GEJ330C	
19	R41 R42 R43 R44 R45 R46 R47 R48 R49 R50 R51 R52 R53 R54 R55 R56 R57 R58 R59	Surface Mount Resistor	Yageo	RC0201JR-0710KL	
1	U1	Renesas: Low noise, high PSRR, low dropout voltage regulator.	Renesas	RAA214020	
1	U2	FTDI: Single Channel Hi-Speed USB to Multipurpose UART/FIFO IC	FTDI	FT232HQ-REEL	
1	Y2	TXC: 25MHz ±30ppm Crystal 8pF 60 Ohms 4-SMD, No Lead	TXC	7M-25.000MAHV-T	

3. Ordering Information

Part Number	Description		
RC21012_31012-PROG	RC21012A/RC31012A Programmer Board		

4. Revision History

Revision	Date	Description					
1.01	Feb 28, 2023	Corrected two typos in "Operational Characteristics"; both required changing 40-pin to 48-pin.					
1.00	Aug 18, 2022	Initial release.					